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CONFIRMATION NO. 9101

SERIAL NUMBER 10/722,299	FILING DATE 11/25/2003  RULE	CLASS 438	GROUP ART UNIT 1763	ATTORNEY DOCKET NO. OPP 031050 US
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## APPLICANTS

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\*\* CONTINUING DATA \*\*\*\*\*

gag 8-051

\*\* FOREIGN APPLICATIONS \*\*\*\*\*

REPUBLIC OF KOREA 10-2002-0080763 12/17/2002

gag 8-051

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 02/26/2004

Foreign Priority claimed

35 USC 119 (a-d) conditions met

Verified and Acknowledged

☒ yes ☐ no  
☒ yes ☐ no ☐ Met after Allowance  
 Examiner's Signature gag 8-051 Initials

STATE OR  
COUNTRY  
KOREA, REPUBLIC  
OF

SHEETS  
DRAWING  
5

TOTAL  
CLAIMS  
8

INDEPENDENT  
CLAIMS  
2

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## TITLE

Bonding pad of a semiconductor device and formation method thereof

FILING FEE  
  
RECEIVED  
770

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